

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	30	V		
Gate-Source Voltage			Vgss	±20	V		
Continuous Drain Current, V _{GS} = 10V (Note 7)	Steady State	Tc = +25°C Tc = +70°C	ID	16 13	А		
Maximum Body Diode Forward Current (Note 7)			ls	8	A		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	50	A		
Pulsed Drain Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			ised Drain Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		lsм	50	A
Avalanche Current (L = 0.1mH) (Note 8)			alanche Current (L = 0.1mH) (Note 8)		I _{AS}	13	A
Avalanche Energy (L = 0.1mH) (Note 8)			Eas	8.5	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.0	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{θJA}	117	°C/W	
Total Power Dissipation (Note 6)		PD	1.5	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{θJA}	81	°C/W	
Thermal Resistance, Junction to Case (Note 7)		Rejc	20	C/VV	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BVDSS	30.0	—	_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	—	—	1.0	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	VGS(TH)	1.0	—	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance		_	_	20	mΩ	V _{GS} = 10V, I _D = 9.0A	
	R _{DS(ON)}		_	32		V _{GS} = 4.5V, I _D = 7.0A	
Diode Forward Voltage	Vsd	_	_	1.2	V	$V_{GS} = 0V$, $I_S = 2A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	393	—	pF		
Output Capacitance	Coss	_	173	_	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss		27		pF		
Gate Resistance	Rg	_	1.1	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg		7.0		nC	V _{DD} = 15V, I _D = 9A	
Total Gate Charge (VGS = 4.5V)	Qg	—	3.6	—	nC		
Gate-Source Charge	Qgs		0.9		nC		
Gate-Drain Charge	Qgd		1.5		nC		
Turn-On Delay Time	tD(ON)		1.8		ns	$V_{DD} = 15V, V_{GS} = 10V,$ $R_G = 6\Omega, I_D = 9A$	
Turn-On Rise Time	t _R		1.9		ns		
Turn-Off Delay Time	tD(OFF)	—	7.5	—	ns		
Turn-Off Fall Time	tF	—	2.4	_	ns		
Reverse Recovery Time	trr	—	10	_	ns	IF = 9A, dl/dt = 100A/µs	
Reverse Recovery Charge	Qrr		2.6		nC		

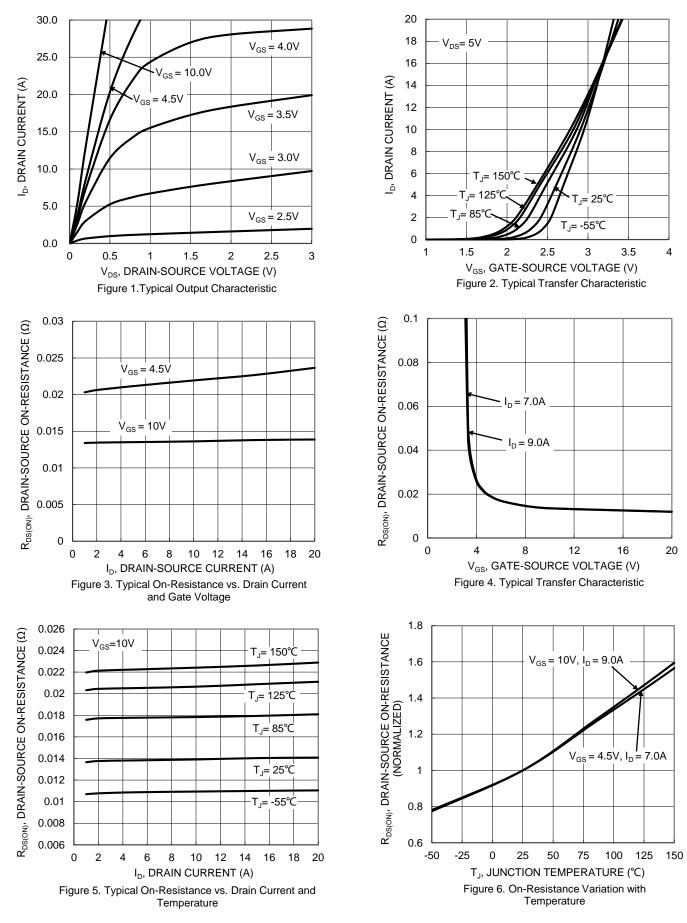
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:

8. IAS and EAS ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.





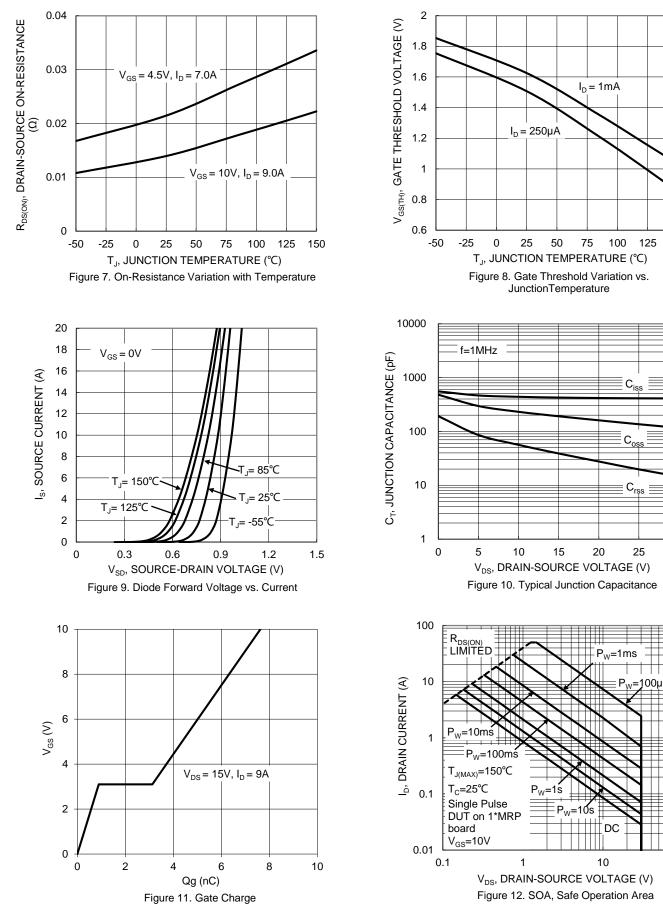
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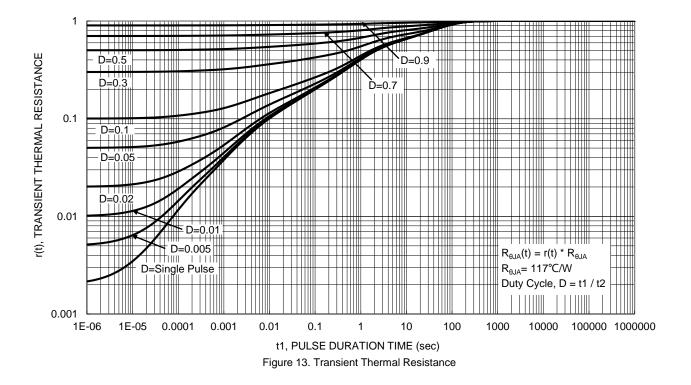
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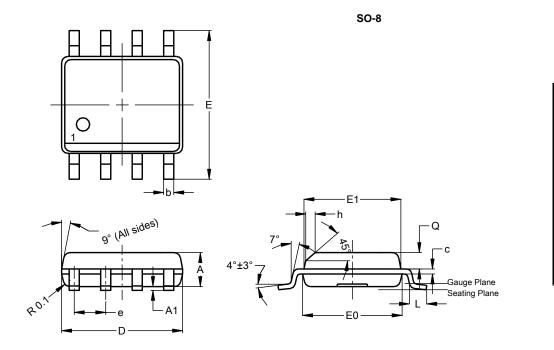






Package Outline Dimensions

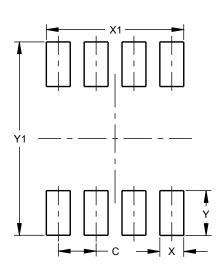
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SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
С	0.15	0.25	0.20			
D	4.85	4.95	4.90			
E	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е			1.27			
h			0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50

SO-8



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